

# LC7574NE, 7574NW

## 1/2 Duty VFD Driver for Frequency Display



CMOS LSI

### **Overview**

The LC7574NE and LC7574NW are 1/2 duty VFD drivers that can be used for electronic tuning frequency display and other applications under the control of a controller. These products can directly drive VFDs with up to 74 segments.

### **Features**

- 74 segment outputs
- Noise reduction circuits are built into the output drivers.
- Serial data input supports CCB\* format communications with the system controller.
- Switching between digital and analog dimmers under serial data control
- High generality since display data is displayed without the intervention of a decoder
- All segments can be turned off with the  $\overline{BLK}$  pin
  - CCB is a trademark of SANYO ELECTRIC CO., LTD.
  - CCB is SANYO's original bus format and all the bus addresses are controlled by SANYO.

### **Package Dimensions**

unit: mm

3156-QFP48E



unit: mm

#### 3163A-SQFP48



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## **Specifications**

## Absolute Maximum Ratings at $Ta=25^{\circ}C,\,V_{SS}$ = 0 V

Parameter	Symbol	Conditions	Ratings	Unit
	V <sub>DD</sub> max	V <sub>DD</sub>	-0.3 to +6.5	V
Maximum supply voltage	V <sub>FL</sub> max	V <sub>FL</sub>	-0.3 to +21.0	V
Input voltage	V <sub>IN</sub> 1	DI, CL, CE, BLK, DIM	-0.3 to +6.5	V
Input voltage	V <sub>IN</sub> 2	OSC	–0.3 to V <sub>DD</sub> + 0.3	V
Output voltage	V <sub>OUT</sub> 1	S1 to S37, G1, G2	–0.3 to V <sub>FL</sub> + 0.3	V
Output voltage	V <sub>OUT</sub> 2	OSC	–0.3 to V <sub>DD</sub> + 0.3	V
Output current	I <sub>OUT</sub> 1	S1 to S37	5	mA
Output current	I <sub>OUT</sub> 2	G1, G2	67	mA
Allowable power dissipation	Ddmay	Ta = 85°C (LC7574NE)	250	mW
Allowable power dissipation	Pd max	Ta = 85°C (LC7574NW)	150	mW
Operating temperature	Topr		-40 to +85	°C
Storage temperature	Tstg		-50 to +125	°C

## Allowable Operating Ranges at Ta=-40 to $+85^{\circ}C,\,V_{DD}$ = 4.5 to 5.5 V, $V_{SS}$ = 0 V

Parameter	Symbol	Conditions	min	typ	max	Unit
Supply voltage	V <sub>DD</sub>	V <sub>DD</sub>	4.5	5.0	5.5	V
Supply voltage	V <sub>FL</sub>	V <sub>FL</sub>	8	12	18	V
Input high level voltage	VIH	DI, CL, CE, BLK	0.8 V <sub>DD</sub>		5.5	V
Input low level voltage	V <sub>IL</sub>	DI, CL, CE, BLK	0		0.2 V <sub>DD</sub>	V
Guaranteed oscillator range	fosc	OSC	0.4	1.6	3.0	MHz
Recommended external resistance	R <sub>OSC</sub>	OSC		12		kΩ
Recommended external capacitance	C <sub>OSC</sub>	OSC		50		pF
Low level clock pulse width	t <sub>øL</sub>	CL: Figure 1	0.5			μs
High level clock pulse width	t <sub>øH</sub>	CL: Figure 1	0.5			μs
Data setup time	t <sub>ds</sub>	DI, CL: Figure 1	0.5			μs
Data hold time	t <sub>dh</sub>	DI, CL: Figure 1	0.5			μs
CE wait time	t <sub>cp</sub>	CE, CL: Figure 1	0.5			μs
CE setup time	t <sub>cs</sub>	CE, CL: Figure 1	0.5			μs
CE hold time	t <sub>ch</sub>	CE, CL: Figure 1	0.5			μs
BLK switching time	t <sub>c</sub>	BLK, CE: Figure 3	10			μs
Input voltage range	V <sub>IN</sub>	DIM	0		+5.5	V

### **Electrical Characteristics** in the Allowable Operating Ranges

Parameter	Symbol	Conditions	min	typ	max	Unit
Input high level current	I <sub>IH</sub>	DI, CL, CE, $\overline{\text{BLK}}$ , DIM: V <sub>I</sub> = 5.5 V			5	μA
Input low level current	IL	DI, CL, CE, $\overline{\text{BLK}}$ , DIM: V <sub>I</sub> = 0 V	-5			μA
	V <sub>OH</sub> 1	S1 to S37: I <sub>O</sub> = 2 mA	V <sub>FL</sub> – 0.6			V
Output high level voltage	V <sub>OH</sub> 2	G1, G2: I <sub>O</sub> = 25 mA	V <sub>FL</sub> - 0.6			V
	V <sub>OH</sub> 3	G1, G2: I <sub>O</sub> = 50 mA	V <sub>FL</sub> – 1.3			V
Output low level voltage	V <sub>OL</sub>	S1 to S37, G1, G2: I <sub>O</sub> = -5 μA, Ta = 25°C	0.125	0.25	0.5	V
Oscillator frequency	fosc	$R_{OSC} = 12 \text{ k}\Omega, C_{OSC} = 50 \text{ pF}$		1.6		MHz
Hysteresis voltage	V <sub>H</sub>	DI, CL, CE, BLK	0.5			V
A/D converter linearity error	Err	DIM	-1/2		+1/2	LSB
Current drain	I <sub>DD</sub>	Outputs open: f <sub>OSC</sub> = 1.6 MHz			10	mA

#### **Pin Assignment**



1. When CL is stopped at the low level









#### **Block Diagram**



#### **Pin Functions**

Pin No.	Pin	I/O	Function		Handling when unused		
4	V <sub>FL</sub>	_	Driver block power supply. A voltage of between 8.0	Driver block power supply. A voltage of between 8.0 and 18.0 V must be supplied.			
1	V <sub>DD</sub>	_	Logic block power supply. A voltage of between 4.5	and 5.5 V must be supplied.	—		
46	V <sub>SS</sub>	—	Ground. Must be connected to the system ground.		—		
48	OSC	I/O	Dscillator connection. An oscillator circuit is formed by connecting an external resistor and capacitor o this pin		V <sub>DD</sub>		
47	BLK	I	<u>Disp</u> lay off control input $\underline{BLK}$ = low (V <sub>SS</sub> ): Display off (G1 and G2 = low) BLK = high (V <sub>DD</sub> ): Display on Note that serial data can be transferred while the display is turned off.		GND		
44	CL	I	Ι	Ι		CL: synchronization clock	
43	DI				I	Serial data transfer inputs. These pins must be connected to the system controller.	DI: transfer data
42	CE	Ī		CE: chip enable			
45	DIM	I	When the analog dimmer is selected, the analog voltage applied to this pin controls the duty of the G1 and G2 digit output pins. Since a 6-bit A/D converter is applied to this analog voltage and that result is input to a decoder that provides a built-in dimmer curve, the relationship between the analog voltage and the duty can be specified as a mask program. Note that $63/96 \cdot V_{DD}$ is the full-scale level for the 6-bit A/D converter.		GND		
2, 3	G1, G2	0	Digit outputs. The frame frequency f <sub>O</sub> is (f <sub>OSC</sub> /4096) Hz		Open		
41 to 5	S1 to S37	0	Segment outputs for displaying the display data transferred by serial data input.		Open		

#### Serial Data Transfer Format

1. When CL is stopped at the low level



#### 2. When CL is stopped at the high level





CCB address:	Transfer $1010_{\rm B}$ , as shown in Figure 2.
M0:	Digital/analog dimmer selection data
	M0 = 0Digital dimmer
	M0 = 1Analog dimmer
DM0 to DM9	: Dimmer data
	This data controls the duty of the G1 and G2 digit output pins when the digital dimmer is selected.
	This data consists of 10 bits, of which DM0 is the LSB. Note that display intensity can be adjusted by
	controlling the duty of the G1 and G2 digit output pins. (The DM0 to DM9 dimmer data is ignored
	when the analog dimmer is selected.)
SD1 to SD74	: Display data
	SD1 to SD37Display data for the G1 digit output pin
	SD38 to SD74Display data for the G2 digit output pin
	SDn (n = 1 to 74) = 1Display on
	SDn (n = 1 to 74) = 0Display off
T0:	Test data
	The T0 bit must be set to 0.

#### **Serial Data Format**



### Correspondence between Display Data (SD1 to SD74) and Segment Output Pins

Segment output pin	G1	G2
S1	SD1	SD38
\$2	SD2	SD39
\$3	SD3	SD40
S4	SD4	SD41
S5	SD5	SD42
S6	SD6	SD43
S7	SD7	SD44
S8	SD8	SD45
S9	SD9	SD46
S10	SD10	SD47
S11	SD11	SD48
S12	SD12	SD49
S13	SD13	SD50
S14	SD14	SD51
S15	SD15	SD52
S16	SD16	SD53
S17	SD17	SD54
S18	SD18	SD55
S19	SD19	SD56

Segment output pin	G1	G2
S20	SD20	SD57
S21	SD21	SD58
S22	SD22	SD59
S23	SD23	SD60
S24	SD24	SD61
S25	SD25	SD62
S26	SD26	SD63
S27	SD27	SD64
S28	SD28	SD65
S29	SD29	SD66
S30	SD30	SD67
S31	SD31	SD68
S32	SD32	SD69
S33	SD33	SD70
S34	SD34	SD71
S35	SD35	SD72
S36	SD36	SD73
S37	SD37	SD74

Example: Segment output pin S11 is controlled as follows:

Display data		Segment output pin S11 state	
SD11	SD48	Segment output pin STT state	
0	0	The segments corresponding to both the G1 and G2 digit output pins are off.	
0	1	The segment corresponding to the G2 digit output pin is on.	
1	0	The segment corresponding to the G1 digit output pin is on.	
1	1	The segments corresponding to both the G1 and G2 digit output pins are on.	

#### **BLK** and the Display Control

Since the LSI internal data (SD1 to SD74 and the control data) is undefined when power is first applied, the display is off (G1 and G2 = low) by setting the  $\overline{BLK}$  pin low at the same time as power is applied. Then, meaningless display at power on can be prevented by transferring all 92 bits of serial data from the controller while the display is off and setting  $\overline{BLK}$  pin high after the transfer completes. (See Figure 3.)

#### **Power Supply Sequence**

The following sequences must be observed when power is turned on and off. (See Figure 3)

- Power on: Logic block power supply (V<sub>DD</sub>) on  $\rightarrow$  Driver block power supply (V<sub>FL</sub>) on
- Power off: Driver block power supply (V<sub>DD</sub>) off  $\rightarrow$  Logic block power supply (V<sub>DD</sub>) off





Output Waveforms (S1 to S37)



#### **Relation between Segment and Digit Outputs**





#### Descriptions

- 1. Consider the examples shown in Figure 4, where data is set up so that the segment outputs S1 to S37 output a low level on the G1 digit output timing and a high level on the G2 digit output timing. (Here, the G2 side being lighted)
- 2. The digit output G1 and G2 waveforms in Example 1 are output when the 10 bits of dimmer data (DM0 to DM9) are set to  $3FE_{\text{H}}$ . The relation between t1 and the oscillator frequency  $f_{\text{OSC}}$  is:

 $t1 = 2/f_{OSC}$ .

For example, if  $f_{OSC} = 1.6$  [MHz], then

t1 = 2/1.6 [MHz] = 1.25 [µs].

Note that t1 and t2 are the same period in Example 1.

3. The digit output G1 and G2 waveforms in Example 2 are those when the dimmer data (DM0 to DM9) are set to a smaller value. Although the time t1, which is from the point where digit output falls to segment output changes, does not change, the time t2, which is from the point where segment output changes to the time the digit output rises, becomes longer. When the dimmer data (DM0 to DM9) are set to 0FF<sub>H</sub> and f<sub>OSC</sub> is 1.6 [MHz], then the frame frequency f<sub>O</sub> is:

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\begin{split} f_{O} &= 1/(t3\times2) \\ &= f_{OSC}/4096 \\ &= 391 \text{ [Hz],} \\ \text{and,} \\ t3 &= 1.28 \text{ [ms].} \end{split}
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Therefore,

 $t2 = \frac{(1.28 \text{ [ms]} - 1.25 \text{ [}\mu\text{s}\text{]} \times 2) \times (3\text{FF}_{\text{H}} - 0\text{FF}_{\text{H}})}{1023} = 0.96 \text{ [ms]}.$ 

4. When the dimmer data (DM0 to DM9) are set to an even smaller value, the time t2, which is from the point where segment output changes to the time the digit output rises, becomes even longer, as in Example 3. Note that t1 does not change here, either.

#### **Sample Application Circuit**



#### **Usage Notes**

1. Notes on the segment and digit waveforms



The segment waveform is distorted by the VFD panel used and the wiring, and furthermore, in the case of being used with essentially no dimming as in the digit waveform 1, as shown in Figure 5, the VFD panel glow dimly. By carefully considering the segment waveform, it can be seen that this problem can be resolved by applying an adequate amount of dimming, as shown in Digit waveform 2. When  $f_{OSC}$  is 1.6 [MHz], we recommend using 10 bits of dimmer data in the range  $000_{\rm H}$  to  $3E0_{\rm H}$ .

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